MA3J700 (MA10700)

Silicon epitaxial planar type

For high frequency rectification

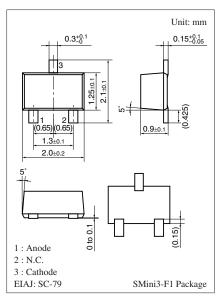
■ Features

- Forward current (Average) I_{F(AV)} = 500 mA rectification is possible
- Optimum for high frequency rectification because of its short reverse recovery time t_{rr}

■ Absolute Maximum Ratings $T_a = 25$ °C

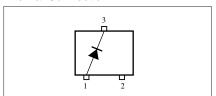
| Parameter | Symbol | Rating | Unit |
|---|--------------------|-------------|------|
| Reverse voltage | V_R | 40 | V |
| Repetitive peak reverse voltage | V_{RRM} | 40 | V |
| Forward current (Average) | I _{F(AV)} | 500 | mA |
| Non-repetitive peak forward surge current * | I _{FSM} | 2 | A |
| Junction temperature | T _j | 125 | °C |
| Storage temperature | T_{stg} | -55 to +150 | °C |

Note) *: The peak-to-peak value in one cycle of 50 Hz sine wave (non-repetitive)



Marking Symbol: M2W

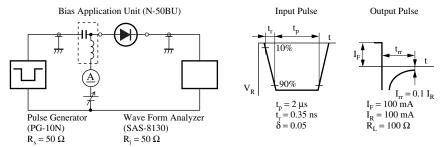
Internal Connection



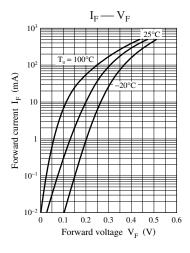
■ Electrical Characteristics $T_a = 25$ °C ± 3 °C

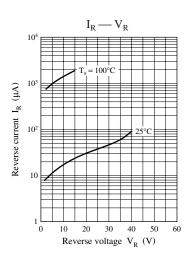
| Parameter | Symbol | Conditions | Min | Тур | Max | Unit |
|-------------------------|-----------------|--|-----|-----|------|------|
| Forward voltage | V _F | $I_F = 500 \text{ mA}$ | | | 0.55 | V |
| Reverse current | I_R | $V_R = 35 \text{ V}$ | | | 100 | μΑ |
| Terminal capacitance | C _t | $V_R = 0 \text{ V, f} = 1 \text{ MHz}$ | | 60 | | pF |
| Reverse recovery time * | t _{rr} | $I_F = I_R = 100 \text{ mA}$ | | 5 | | ns |
| | | $I_{rr} = 0.1 I_R, R_L = 100 \Omega$ | | | | |

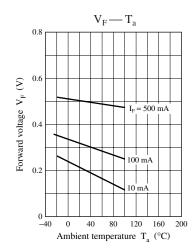
- Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.
 - 2. This product is sensitive to electric shock (static electricity, etc.). Due attention must be paid on the charge of a human body and the leakage of current from the operating equipment.
 - 3. Absolute frequency of input and output is 400 MHz.
- 4.*: t_{rr} measurement circuit

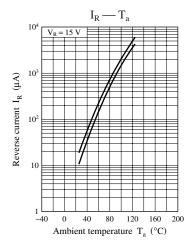


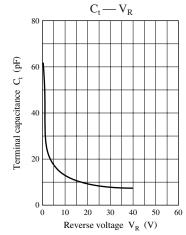
Note) The part number in the parenthesis shows conventional part number.

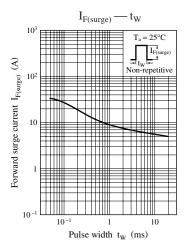












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